# **Surface Mount Fuses**

# Thin Film > 1206 Size > Very Fast-Acting > 466 Series

# RoHS



# **466 Series Fuse**







#### **Agency Approvals**

AGENCY	AGENCY FILE NUMBER	AMPERE RANGE
<b>9</b>	E10480	125MA - 5A
<b>⊕</b> ®	LR29862	125MA - 5A

# **Electrical Characteristics for Series**

% of Ampere Rating	Opening Time at 25°C	
100%	4 hours, Minimum	
200%	5 sec., Maximum	
300%	0.2 sec., Maximum	

## **Description**

The 466 Series Fast-Acting Surface Mount Fuse (SMF) is a small (1206 size) thin-film device designed for secondary protection of circuits used in space constrained applications such as hand-held portable electronic devices.

This series is 100% lead-free and meets the requirements of the RoHS directive. New Halide-Free 466 Series fuses are available-to order use the "HF" suffix. See Part Numbering section for additional information.

## **Features**

- Product is compatible with lead-free solders and higher temperature profiles.
- Product is marked on top surface with code to allow amperage rating identification without testing.
- Low profile for height sensitive applications.
- Flat top surface for pickand-place operations.

- Element covering material is resistant to industry standard cleaning operations.
- Mounting pad and electrical performance is identical to Littelfuse 429 and 433 Series products.
- Alloy based element construction provides superior inrush withstand characteristics (I2t) over ceramic or glass based 1206 chip fuse products.

#### **Applications**

Secondary protection for space constrained applications:

- Cell phones
- DVD players
- Battery packs
- Hard disk drives.
- Digital cameras

## **Electrical Specifications by Item**

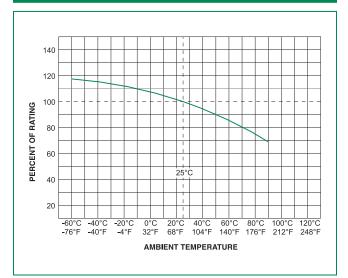
Ampere Rating (A)	Amp Code	Max Voltage Rating (V)	Interrupting Rating	Nominal Cold Resistance (Ohms)	Nominal Melting I²t (A²sec)	Nom Voltage Drop (mV)	Nom Power Dissipation (W)	Agency A	Approvals ( )®
0.125	.125	125		4.000	0.00040	552.66	0.0691	X	X
0.200	.200	125	50A @125 V AC/	1.160	0.00055	254.28	0.0509	X	X
0.250	.250	125	DC	0.710	0.0010	207.01	0.0518	X	X
0.375	.375	125		0.350	0.0028	169.18	0.0634	X	X
0.500	.500	63	50A @63 V AC/DC	0.248	0.0060	158.47	0.0792	X	X
0.750	.750	63		0.111	0.0276	98.65	0.0740	X	X
1.00	001.	63		0.076	0.0423	89.94	0.0899	Х	X
1.25	1.25	63		0.059	0.0640	85.71	0.1071	Х	X
1.50	01.5	63		0.048	0.1103	82.97	0.1244	X	X
1.75	1.75	63		0.039	0.1323	80.73	0.1413	Х	X
2.00	002.	63		0.031	0.2326	78.73	0.1575	X	X
2.50	02.5	32	50A @32 V AC/DC	0.024	0.3516	76.99	0.1925	X	X
3.00	003.	32		0.020	0.5760	75.99	0.2280	Х	X
4.00	004.	32		0.014	1.024	74.50	0.2980	Х	X
5.00	005.	32		0.011	1.600	73.75	0.3688	X	X

- 1. Measured at 10% of rated current 25°C.
- 2. Measured at rated voltage

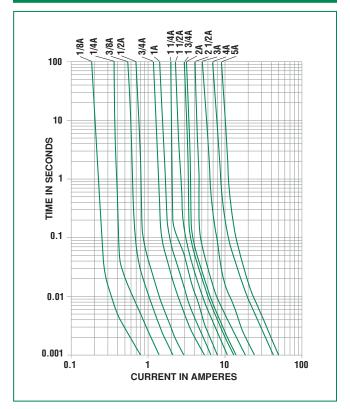
# Thin Film > 1206 Size > Very Fast-Acting > 466 Series



# **Temperature Rerating Curve**



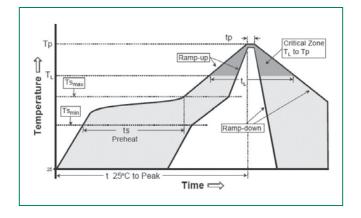
# **Average Time Current Curves**



# **Soldering Parameters**

Reflow Co	ndition	Pb – Free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (Min to Max) (t <sub>s</sub> )	60 – 180 secs	
Average ra	amp up rate (Liquidus Temp k	5°C/second max	
T <sub>S(max)</sub> to T <sub>L</sub>	- Ramp-up Rate	5°C/second max	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
	-Temperature (t <sub>L</sub> )	60 – 150 seconds	
PeakTemp	perature (T <sub>P</sub> )	250 <sup>+0/-5</sup> °C	
Time with Temperate	in 5°C of actual peak ure (t <sub>p</sub> )	20 - 40 seconds	
Ramp-dov	vn Rate	5°C/second max	
Time 25°C	to peakTemperature (T <sub>P</sub> )	8 minutes Max.	
Do not exc	ceed	260°C	





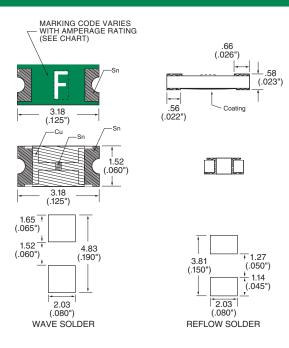
# **Surface Mount Fuses** Thin Film > 1206 Size > Very Fast-Acting > 466 Series

## **Product Characteristics**

	<b>Body:</b> Advanced High Temperature Substrate		
Materials	Terminations: 100% Tin over Nickel over		
iviaterials	Copper		
	Element Cover Coat: Conformal Coating		
Operating	– 55°C to 90°C.		
Temperature	Consult temperature rerating curve chart.		
<b>Thermal Shock</b> Withstands 5 cycles of –55°C to 125°C			
Humidity	MIL-STD-202F, Method 103B, Condition D		

Vibration	Per MIL-STD-202F, Method 201A		
Insulation Resistance (After Opening)	Greater than 10,000 ohms		
Resistance to Soldering Heat	MIL-STD-202G, Method 210F, Condition D		

## **Dimensions**



# **Part Marking System**

Amp Code	Marking Code
.125	В
.200	С
.250	D
.375	E
.500	F
.750	G
001.	Н
1.25	J
01.5	К
1.75	L
002.	N
02.5	0
003.	Р
004.	S
005.	Т

# **Part Numbering System**



#### Example:

.125 amp product is 0466.125 NR HF (2 amp product shown above).

# **Packaging**

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
8mm Tape and Reel	EIA RS-481-2 (IEC 286, part 3)	5000	NR